

### TDM3436

#### **DESCRIPTION**

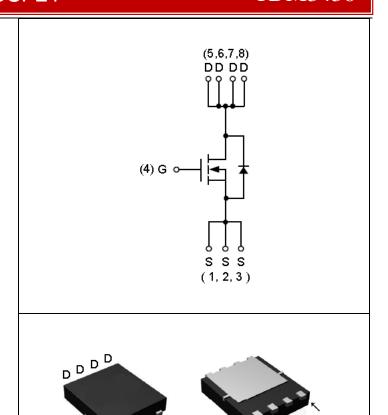
The TDM3436 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

#### **GENERAL FEATURES**

- RDS(ON) < 4.1mΩ @ VGS=4.5V</li>
   RDS(ON) < 3.1mΩ @ VGS=10V</li>
- High Power and current handling capability
- Lead free product is available
- Surface Mount Package

### **Application**

- PWM applications
- Load switch
- Power management



DFN5x6-8

#### ABSOLUTE MAXIMUM RATINGS(TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	VDS	40	V			
Gate-Source Voltage	VGS	<u>+</u> 20	V			
Durin Courset & Continuous	ID (TA=25°C)	25	Α			
Drain Current @ Continuous	ID (TA=70°C)	20	А			
Drain Current @ Current-Pulsed (Note 1)	IDM (Tc=25°С)	300	А			
Drain Current @ Continuous	ID (Tc=25℃)	100	А			
	ID (Tc=100°C)	78	А			
Maximum Power Dissipation (T <sub>A</sub> =25 $^{\circ}$ C)	PD	2.7	W			
Maximum Operating Junction Temperature	Tı	150	$^{\circ}$			
Storage Temperature Range	Тѕтс	-55 To 150	$^{\circ}$ C			
THERMAL CHARACTERISTICS						
Thermal Resistance, Junction-to-Ambient (Note 1)	Reja	50	°C/W			



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### **ELECTRICAL CHARACTERISTICS** (TA=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit		
OFF CHARACTERISTICS						•		
Drain-Source Breakdown Voltage	BVDSS	V <sub>G</sub> S=0V I <sub>D</sub> =250μA 40		-	-	V		
Zero Gate Voltage Drain Current	IDSS	Vps=32V,Vgs=0V		-	1	μА		
Gate-Body Leakage Current	Igss	Vgs=±20V,Vps=0V	-	-	±100	nA		
ON CHARACTERISTICS (Note 2)								
Gate Threshold Voltage	VGS(th)	Vps=VGS,Ip=250μA	1.4	1.7	2.5	V		
Drain-Source On-State Resistance	Rds(on)	Vgs=4.5V, ID=20A	-	3.1	4.1	mΩ		
		Vgs=10V, Ip=25A	-	2.4	3.1	mΩ		
DYNAMIC CHARACTERISTICS (Note4)								
Input Capacitance	Ciss	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V, F=1.0MHz	-	2650	-	PF		
Output Capacitance	Coss		-	750	-	PF		
Reverse Transfer Capacitance	Crss		-	88	-	PF		
SWITCHING CHARACTERISTICS (Note 3)						•		
Turn-on Delay Time	td(on)	VDS=20V, RL=20 $\Omega$ , VGEN=10V,RG=6 $\Omega$	-	17	-	nS		
Turn-on Rise Time	tr	ID=1A	-	11.5	-	nS		
Turn-Off Delay Time	td(off)		-	36	-	nS		
Turn-Off Fall Time	tf		-	31	-	nS		
Total Gate Charge	Qg	V <sub>DS</sub> =20V,I <sub>D</sub> =25A,V <sub>GS</sub> =4.5V	-	17	-	nC		
Gate-Source Charge	Qgs		-	7	-	nC		
Gate-Drain Charge	Qgd		-	5.3	_	nC		
Body Diode Reverse Recovery Time	Trr	I <sub>F</sub> =5A, dI/dt=100A/μs	-	38	_	nS		
Body Diode Reverse Recovery Charge	Qrr		-	35	_	nC		
DRAIN-SOURCE DIODE CHARACTERISTIC	S		•	•	•			
Diode Forward Voltage (Note 2)	VsD	V <sub>G</sub> s=0V,I <sub>S</sub> =20A	-	0.8	1.1	V		

#### NOTES:

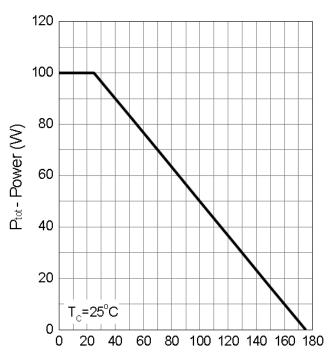
- 1. Pulse width limited by max. junction temperature.
- 2. Pulse Test: Pulse Width  $\, \leqslant \, 300 \mu s$ , Duty Cycle  $\, \leqslant \, \, 2\%$ .
- 3. Guaranteed by design, not subject to production testing



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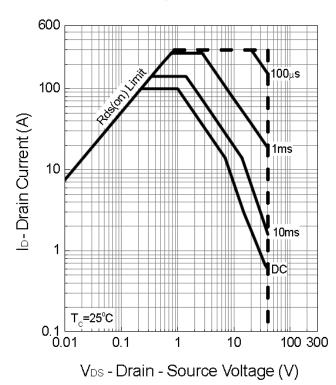
### **Typical Operating Characteristics**

#### **Power Dissipation**

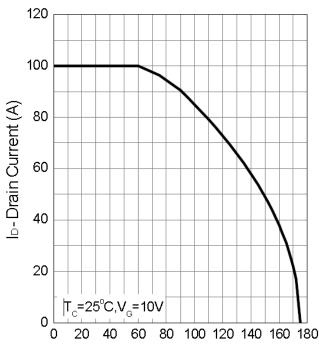


T<sub>j</sub> - Junction Temperature (°C)

#### Safe Operation Area

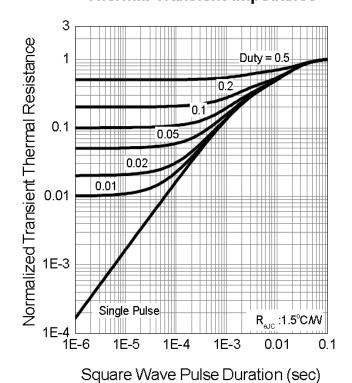


#### **Drain Current**



T<sub>j</sub>- Junction Temperature (°C)

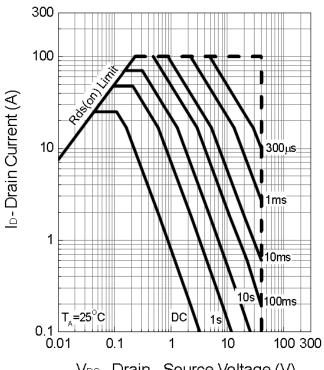
#### Thermal Transient Impedance





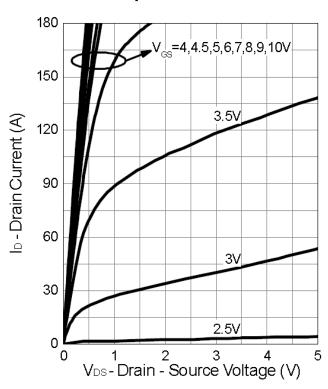
### **Typical Operating Characteristics(Cont.)**

#### Safe Operation Area

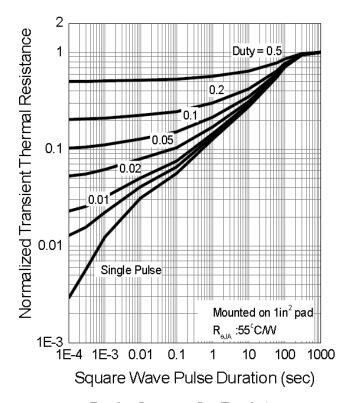


VDS - Drain - Source Voltage (V)

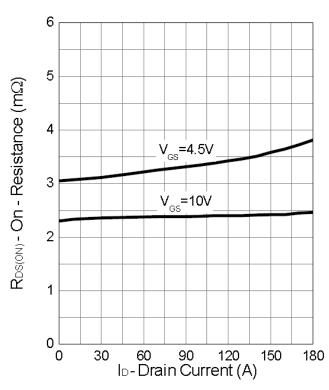
#### **Output Characteristics**



#### Thermal Transient Impedance



#### Drain-Source On Resistance

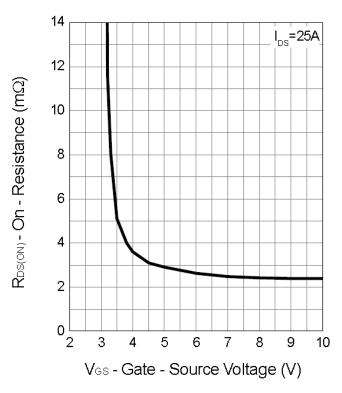




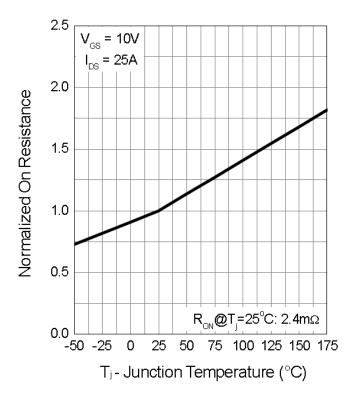
### TDM3436

### **Typical Operating Characteristics (Cont.)**

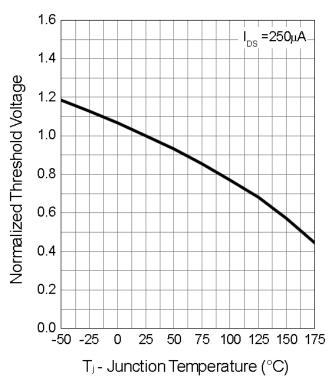




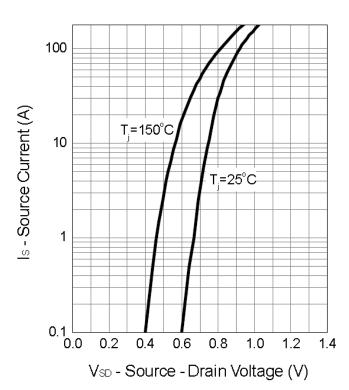
#### **Drain-Source On Resistance**



### **Gate Threshold Voltage**



#### Source-Drain Diode Forward

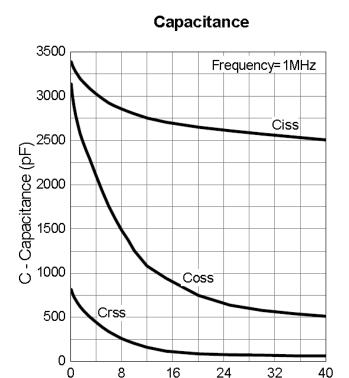


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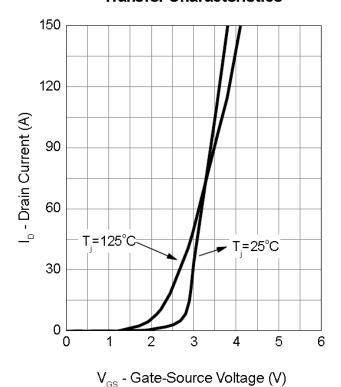
## N-Channel Enhancement Mode MOSFET

### **Typical Operating Characteristics (Cont.)**

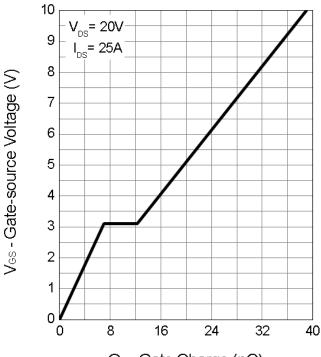


VDS - Drain-Source Voltage (V)

#### **Transfer Characteristics**



#### **Gate Charge**



Q<sub>G</sub> - Gate Charge (nC)

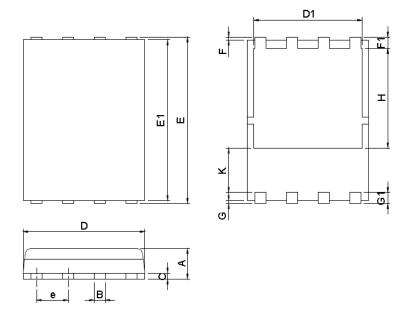
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## N-Channel Enhancement Mode MOSFET

### **Package Information**

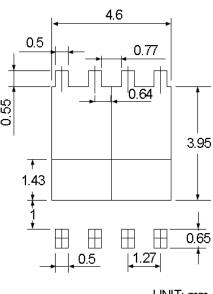
#### DFN5\*6-8 Package



ş	DFN5x6-8						
SYMBOL	MILLIM	ETERS	INCHES				
ုပ	MIN.	MAX.	MIN.	MAX.			
Α	0.90	1.20	0.035	0.047			
В	0.3	0.51	0.012	0.020			
С	0.19	0.25	0.007	0.010			
D	4.80	5.30	0.189	0.209			
D1	4.00	4.40	0.157	0.173			
E	5.90	6.20	0.232	0.244			
E1	5.50	5.80	0.217	0.228			
е	1.27 BSC		0.050 BSC				
F	0.05	0.30	0.002	0.012			
F1	0.35	0.75	0.014	0.030			
G	0.05	0.30	0.002	0.012			
G1	0.35	0.75	0.014	0.030			
Н	3.34	3.9	0.131	0.154			
к	0.762	-	0.03	-			

## Note: 1.Dimension D, D1,D2 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 10 mil.

#### RECOMMENDED LAND PATTERN



UNIT: mm



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**Design Notes**